



Connectors > High Speed Pluggable IO Connectors & Cages > zSFP+ Cage Assembly: EMI Springs



Pluggable I/O Product Type: **Cage Assembly**

Sealable: **No**

Circuit Application: **Signal**

Operating Temperature Range: **-55 – 105 °C [-67 – 221 °F]**

Data Rate (Max): **28 Gb/s**

[All zSFP+ Cage Assembly: EMI Springs \(21\)](#)

Features

Product Type Features

Cage Type	Ganged
Pluggable I/O Product Type	Cage Assembly
Sealable	No
Form Factor	zSFP+

Configuration Features

Number of Ports	4
Port Matrix Configuration	1 x 4

Electrical Characteristics

Data Rate (Max)	28 Gb/s
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Termination Features

Termination Method to PCB	Through Hole - Press-Fit
Termination Post & Tail Length	2.05 mm[.071 in]

Housing Features

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Cage Material	Nickel Silver Alloy
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Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application

Pluggable I/O Applications	EMI Enhanced
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Heat Sink Compatible	No
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Circuit Application	Signal
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Packaging Features

Packaging Method	Tray
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Other

Included Lightpipe	No
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EMI Containment Feature Type	Internal/External EMI Springs
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
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EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
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Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
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Solder Process Capability	Not applicable for solder process capability
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Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Customers Also Bought





Documents

Product Drawings

[zSFP+ 1x4 Cage Assembly, Press-Fit](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_2300275-1_A.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2300275-1_A.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2300275-1_A.3d_stp.zip](#)

English

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Product Specifications

[Application Specification](#)

English